





Certificate of Registration

ENVIRONMENTAL MANAGEMENT SYSTEM - ISO 14001:2015

This is to certify that:

Ardentec Corporation

No. 3, Gongye 3rd Rd. Hukou Township Hsinchu County

303036 Taiwan 欣銓科技股份有限公司

臺灣 新竹縣 湖口鄉

工業三路3號 303036

Holds Certificate No:

EMS 693250

and operates an Environmental Management System which complies with the requirements of ISO 14001:2015 for the following scope:

1. The manufacture of WLCSP (Wafer Level Chip Scale Package) and semiconductor device trimming.

2. The production testing of semiconductor device.

For and on behalf of BSI:

Michael Lam - Managing Director Assurance, APAC

Original Registration Date: 2004-08-02

Latest Revision Date: 2024-06-18

Effective Date: 2024-07-25 Expiry Date: 2027-07-24

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...making excellence a habit."

This certificate was issued electronically and remains the property of BSI and is bound by the conditions of contract. An electronic certificate can be authenticated <u>online</u>.

Printed copies can be validated at www.bsi-global.com/ClientDirectory or telephone +886 (02)2656-0333.

Certificate No:

EMS 693250

Location

Registered Activities

The production testing of semiconductor device.

Ardentec Corporation TingShin Site

No. 3, 3-1, Gongye 3rd Rd.

Shengli Vil.

Hukou Township

Hsinchu County

303036

Taiwan

欣銓科技股份有限公司 新工一廠

臺灣

新竹縣

湖口鄉

工業三路3號, 3-1號

303036

Ardentec Corporation Kaiyuan Site

No. 24, Wenhua Rd.

Hukou Township

Hsinchu County

303035 Taiwan

欣銓科技股份有限公司 新工二廠

臺灣

新竹縣

湖口鄉

文化路24號

303035

The manufacture of WLCSP (Wafer Level Chip Scale Package) and semiconductor device trimming.

Ardentec Corporation Gaosheng Site

No. 9, Renyi Rd.

Hukou Township

Hsinchu County

303035

Taiwan

欣銓科技股份有限公司 新工三廠

臺灣

新竹縣

湖口鄉

仁義路9號 303035 The production testing of semiconductor device.

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Taiwan Headquarters: 2nd Floor, No.37, Ji-Hu Rd., Nei-Hu Dist., Taipei 114, Taiwan, R.O.C. A Member of the BSI Group of Companies.

Certificate No:

EMS 693250

Location

Registered Activities

Ardentec Corporation Paoching Site

1F, 6F, 7F

No. 12, Guangfu N. Rd.

Hukou Township

Hsinchu County

303036

Taiwan

欣銓科技股份有限公司 新工五廠

臺灣

新竹縣

湖口鄉

光復北路12號

1、6、7樓

303036

The production testing of semiconductor device.

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